

**IEEE EMC Society Standards Advisory and  
Coordination Committee (SACCom)  
August 17, 2015  
11:15 am to Noon (Dresden time)  
International Congress Centre Dresden  
Draft Minutes**

1.	Opening of meeting Welcome & Introductions	Chair	The chair opened the meeting a 11:15 am; attendee introductions were made (see below for attendees)
2.	Duty to Inform (Patents Slides) (secretary) <a href="https://development.standards.ieee.org/myproject/Public/mytools/mob/preparslides.pdf">https://development.standards.ieee.org/myproject/Public/mytools/mob/preparslides.pdf</a>	Secretary	The patent slides were shown and all agreed to abide by them
3.	Approve minutes of Santa Clara Minutes	Secretary	There were no objections to approving the minutes
4.	Review EMCS Website for SACCom <a href="http://www.ewh.ieee.org/soc/emcs/standards/saccomindex.html">http://www.ewh.ieee.org/soc/emcs/standards/saccomindex.html</a>	Secretary	Each page of the web site was reviewed noting no problems at this time
5.	Review Membership list and email updates <a href="http://www.ewh.ieee.org/soc/emcs/standards/saccomindex.html">http://www.ewh.ieee.org/soc/emcs/standards/saccomindex.html</a>	Secretary	The membership list on the web site was reviewed noting a need for a representative for CENELEC TC210 and that David Brumbaugh has changed his email address as he is no longer affiliated with Boeing
	Present plans for	Chair	There are no plans to

6.	remainder of 2015		have a meeting at a symposium for the rest of the year
	Review of SACCom organization meetings in 2015	Vice chairman	Andy Marvin took the action to reconstruct the SACCom member meeting information including deleting past meetings and putting the meetings in date order to easily find
7.	Present update reports received from SACCom members <a href="http://www.emcs.org/standards/saccom/sac-memberreports.html">http://www.emcs.org/standards/saccom/sac-memberreports.html</a>	SACCom members in attendance	These reports were presented by the reps in attendance: <ol style="list-style-type: none"> <li>1. CISPR/A</li> <li>2. CISPR/I</li> <li>3. ANSI ASC C63</li> <li>4. AAMI</li> <li>5. ITI TC5</li> <li>6. IEC TC 65</li> </ol> Other reports were received by email. All reports will be posted on the SACCom website
8	Plans for next meeting in Florida	Chair	Next meeting is on the 2 <sup>nd</sup> of December in Orlando
9	Adjournment	Meeting adjourned at noontime.	

See next page for attendance

## Attendance:

<b>Name</b>	<b>Affiliation</b>	<b>Email</b>
John Norgard (chair)	NASA/JSC	j.norgard@ieee.org
Andy Marvin (Vice chair)	York EMC Services	Andy.marvin@york.ac.uk
Don Heirman (Secretary)	Don HEIRMAN Consultants	d.heirman@ieee.org
Kim Williams	IEEE	k.williams@ieee.org
Alistair Duffy	De Montfort University	apd@dmu.ac.uk
Ghery Pettit	Pettit EMC Consulting	ghery@pettitemcconsulting.com
David Traver	CEC	davidtraver@comcast.net
Dan Hoolihan	Hoolihan EMC Consulting	danhoolihanemc@aol.com
Ross Carlton	National Instruments	Ross.carlton@ieee.org
Colin Brench	Amphenol HSI	Colin.brench@ieee.org
Bob Scully	NASA	Bob.scully@nasa.gov